

# **Thomas Sekula**

#### **Associate**

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#### **Practice Areas**

Arbitration Trials

### **Education**

University of Texas School of Law, J.D., 2018, high honors; Associate editor, *Texas* Law Review; Order of the Coif

Texas A&M University, B.A., 2014

## **Admissions**

Texas

U.S. District Court for the Southern, Eastern, Northern, and Western Districts of Texas



#### **OVERVIEW**

Thomas handles a variety of complex commercial litigation matters, with particular experience in international and domestic arbitration, cross-border litigation, securities litigation, and complex construction and engineering disputes.

Prior to joining Hicks Johnson, Thomas worked at a large, international firm in Houston. He also served as a judicial clerk for the Hon. Ronald M. Gould of the U.S. Court of Appeals for the Ninth Circuit and the Hon. Fernando Rodriguez Jr. of the U.S. District Court for the Southern District of Texas.

Thomas is fluent in Spanish, Portuguese, and French, with conversational ability in Italian.

## **NOTABLE EXPERIENCE**

## **Representative Matters**

- Represented a US tele-communications company in an international arbitration concerning a complex construction project, related to issues ranging from breach of contract to expropriation.
- Represented a steel company based in Mexico in several breach of contract actions.
- Represented minority shareholders in a complex international securities and breach of contract suit against a foreign state-owned energy company in federal court.
- Represented an international company in two international arbitrations against both a
  foreign municipality and state, concerning among other things issues of breach of contract
  and construction/projects issues.

## **PUBLICATIONS AND SPEAKING ENGAGEMENTS**

"Selective Settlement and the Integrity of the Bellwether Process." 97 TEX. L. REV. 859, 863–67 (2019).

"No Time Like the Past: Preventive Damages in International Law." *The International Lawyer*, Volume 57, Number 2, 2024.